

March 25, 2004

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Fr: George O. Saile     Reg. No. 19,572  
28 Davis Avenue  
Poughkeepsie, N.Y. 12603

Subject:

**Continuation of**  
Serial No.: 10/060,483 1/30/02  
  
YEN-MING CHEN, CHIA-FU LIN, SHUN-LIANG,  
KAI-MING CHING, HSIN-HUI LEE, CHAO-YUAN SU, LI-  
CHIH CHEN  
  
NOVEL METHOD TO IMPROVE BUMP RELIABILITY  
FOR FLIP CHIP DEVICE

**PRELIMINARY AMENDMENT**

Dear Sir:

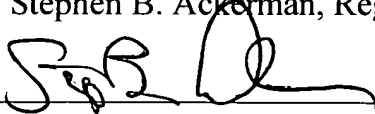
This is a preliminary amendment for the above referenced Continuation. Please  
amend the above identified application for patent as follows:

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the United States  
Postal Service as first class mail in an envelope addressed to: Commissioner of Patents  
and Trademarks, Washington, D.C. 20231, on March 26, 2004.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date



3/26/04

**Continuation Application of**

Appl. No : 10/060,483  
Applicant : Yen-Ming Chen  
Filed : 01/30/02  
TC/A.U. : 2814  
EXAMINER : Trinh, Hoa B.

Docket No. : TS01-413C  
Customer No.: 28112

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

Sir:

Please enter the attached Preliminary Amendment.

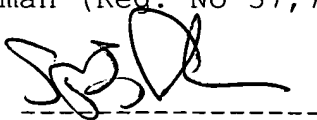
**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** are shown on page 6 of this paper.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on MARCH 26, 2004

Stephen B. Ackerman (Reg. No 37,761)



Signature

3/26/04

Date